



Product Change Notification

Change Notification #: 115213 - 00
Change Title: Intel® Server Kits A2U44X25NVMEDK, A1U44X25NVMEDK, A2U8X25S3HSDK, A2U8X35S3HSDK.
Intel® Server Spares A2UL8RISER2, A2UREARHSDK, F1UL16RISER2, F1U8X25S3HSBP, F2U12X35S3HSBP, F2U8X35S3HSBP, FR1304S3HSBP, FXX8X25S3HSBP.
PCN 115213-00, Product Design, Product Material, System RoHS compliance exemption free conversion and Updated, Firmware update.

Date of Publication: January 3, 2017

Key Characteristics of the Change:

Product Design, Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: * January 11, 2017

* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the products listed in the Products Affected table below:

1. Replacing components containing substances listed under EU RoHS exemption 6(c), 7(c) and 15 with exemption free versions. Components containing substances listed under EU RoHS exemption 7(a) are not affected with the exception of one IC. All new components are identical in form factor and function to the replaced ones.
2. The Firmware installed on the Hot Swap Backplanes will be updated from version 1.12 to version 1.19. This Firmware is the part of the System Update Package that is available for download from <http://www.intel.com/support>. Please refer to the software release notes for a list of changes.

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <http://www.intel.com/support>.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change PBA	Post Change PBA
A2UREARHSDK	934976	G94339-351	G94339-371
A1U44X25NVMEDK	936251	G97154-351	G97154-371
A2U44X25NVMEDK	936253	G97158-351	G97158-371
A2UL8RISER2	934885	H20087-151	H20087-171
F1UL16RISER2	934884	H39531-151	H39531-171
F1U8X25S3HSBP	934888	G97152-352	G97152-371
F2U12X35S3HSBP	934893	G97164-352	G97164-371
F2U8X35S3HSBP	934892	G97160-351	G97160-371
FR1304S3HSBP	934887	G97162-351	G97162-371
FXX8X25S3HSBP	934890	G97156-351	G97156-371
A2U8X25S3HSDK	935066	G97156-351	G97156-371
A2U8X35S3HSDK	936191	G97160-352	G97160-371

PCN Revision History:

Date of Revision:

January 3, 2017

Revision Number:

00

Reason:

Originally Published PCN



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115213 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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